TQS - COMPANY PROPRIETARY INFORMATION	SPEC. NO: REV:	DAT.CLY2 B
SPEC TITLE: CLY2 DATASHEET	PAGE	1 OF 9

REVISION HISTORY

			REVISION HISTORY	T	1
REV	DATE	ECN#	DESCRIPTION OF CHANGE	Internal Web Site?	External Web Site?
A	10-16-03	22355	New release of CLY2 datasheet (formerly DAT.057 rev D); also replaced S-PAR & noise match tables, p. 6 & 7; replaced output charasteristics tables, p. 5; by R. Hamilton.	No	Yes
В	12-06-04	27162	Updated to reflect Ver 1.8, March 4, 2004; revised package name to MW6, p.1; deleted 5V electrical characteristics, p. 7; by M. Rensfeldt	No	Yes
MSW					
NOTE			CONTROLLED DISTRIBUTION:		

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High-Power Packaged GaAs FET

Description:

The CLY2 is a high-breakdown voltage GaAs FET designed for PA driver applications in the 400 MHz to 3 GHz frequency range. It is ideal for portable PA applications in mobile phones and portable WLAN transceivers due to its easy matching and excellent linearity. The CLY2 exhibits +23.5 dBm output power with +3V Vds at 1.8 GHz with an associated gain of 14.5 dB. Power added efficiencies to 55% are achievable.

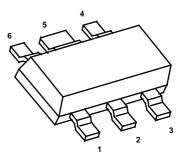
Features:

- For frequencies up to 3 GHz
- Wide operating voltage range: 2 to 6 V
- P_{OUT} 23.5 dBm typical at V_D=3V, f=1.8GHz
- High efficiency: better than 55 %
- Nfmin 0.79 dB typical at 900 MHz
- Low Cost

Applications:

- Power Amplifiers for WLAN transceivers
- Driver Amplifiers for WLAN or mobile phone basestations
- Low Noise Amplifier for basestations and antenna amplifiers

Package Outline, MW6:



Pin Configuration:

1 & 6: Gate 2 & 5: Source 3 & 4: Drain

Maximum Ratings:

Parameter	Symbol	Values	Unit				
Drain-source voltage	V _{DS}	9	V				
Drain-gate voltage	V <i>D</i> G	12	V				
Gate-source voltage	VGS	-6	V				
Drain current	I _D	600	mA				
Channel temperature	T _{Ch}	150	°C				
Storage temperature	T _{stg}	-55+150	°C				
Total power dissipation (T _S ≤ 50 °C) ¹⁾	P _{tot}	900	mW				
Thermal Resistance							
Channel-soldering point 1)	R _{thChS}	≤110	K/W				

¹⁾T_S: Temperature at soldering point

Electrical Specifications:

 $(T_A = 25^{\circ}C$, unless otherwise specified)

Parameter	Symbol	min	typ	max	Unit
Drain-source saturation current	l _{DSS}	300	450	650	mA
$V_{DS} = 3 \text{ V}$ $V_{GS} = 0 \text{ V}$					
Drain-source pinch-off current	/ _D	-	5	50	μΑ
$V_{DS} = 3 \text{ V}$ $V_{GS} = -3.8 \text{ V}$					
Gate pinch-off current	/G	-	5	20	μA
$V_{DS} = 3 \text{ V}$ $V_{GS} = -3.8 \text{ V}$	_				
Pinch-off Voltage	$V_{GS(p)}$	-3.8	-2.8	-1.8	V
V_{DS} = 3 V I_{D} =50 μ A	(17				
Small Signal Gain*)	G	-	15.5	-	dB
$V_{DS} = 5 \text{ V}$ $I_{D} = 180 \text{ mA}$ f = 1.8 GHz					
$P_{in} = -5 \text{ dBm}$					
Small Signal Gain*)	G	-	14.5	-	dB
$V_{DS} = 3 \text{ V}$ $I_{D} = 180 \text{ mA}$ f = 1.8 GHz					
P _{in} = -5 dBm					
Output Power	P_{O}	22.5	23.5	-	dBm
$V_{DS} = 3 \text{ V}$ $I_{D} = 180 \text{ mA}$ f = 1.8 GHz					
P _{in} = 10 dBm					

Electrical Specifications, Continued:

1dB-Compression Point	P _{1dB}	-	23.5	-	dBm
$V_{DS} = 3 \text{ V}$ $I_{D} = 180 \text{ mA}$ f = 1.8 GHz					
1dB-Compression Point	P _{1dB}	-	27.0	-	dBm
$V_{DS} = 5 \text{ V}$ $I_{D} = 180 \text{ mA}$ f = 1.8GHz					
Power Added Efficiency	PAE	-	55	-	%
$V_{DS} = 3 \text{ V}$ $I_{D} = 180 \text{ mA}$ f = 1.8 GHz					
P _{in} = 10 dBm					
Noise figure	NF		1.48		dB
$V_{DS} = 3 \text{ V}$ $I_{D} = 180 \text{ mA}$ f = 1.8GHz					

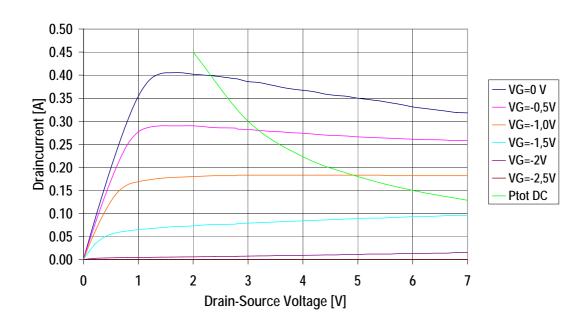
^{*)} Matching conditions for maximum small signal gain (not identical with power matching conditions!)

Source Match: Γ_{ms} : MAG = 0.74, ANG 132°; Load Match: Γ_{ml} : ;MAG 0.61, ANG -153°

^{**)} Power matching conditions: f=1.8GHz:

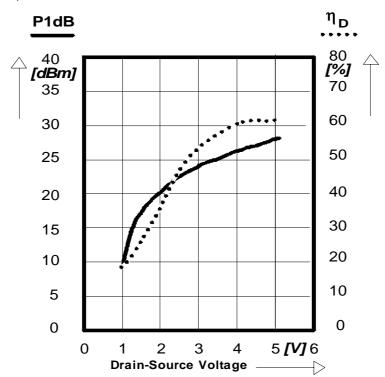
Electrical Characteristics, Continued:

Output characteristics:



Compression Power vs. Drain-Source Voltage

f = 1.8GHz; IDS = 0.5 Idss



Electrical Characteristics, Continued:

Typical Common Source S-Parameters and noise data

 $V_{DS} = 3 V$

 $I_D = 180 \text{ mA}$

 $Z_0 = 50 \Omega$

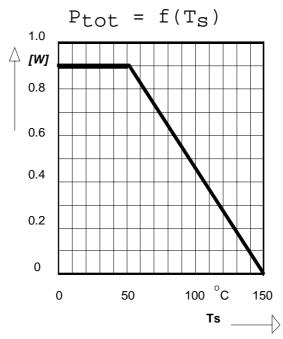
Freq. [GHz]	S11	<s11< td=""><td> S21 </td><td><s21< td=""><td> S12 </td><td><s12< td=""><td> S22 </td><td><\$22</td></s12<></td></s21<></td></s11<>	S21	<s21< td=""><td> S12 </td><td><s12< td=""><td> S22 </td><td><\$22</td></s12<></td></s21<>	S12	<s12< td=""><td> S22 </td><td><\$22</td></s12<>	S22	<\$22
100	0.992	-13.3	10.120	170.7	0.008	101.1	0.115	-34.6
200	0.974	-26.4	9.778	162.6	0.014	74.1	0.140	-57.5
300	0.950	-38.6	9.278	154.7	0.021	74.0	0.171	-72.3
400	0.922	-49.5	8.683	147.8	0.025	68.0	0.200	-82.0
500	0.896	-59.1	8.042	141.8	0.031	64.8	0.226	-89.1
600	0.871	-67.1	7.444	137.0	0.033	63.0	0.248	-93.8
700	0.849	-74.0	6.880	132.5	0.036	60.6	0.267	-96.9
800	0.828	-79.9	6.373	129.1	0.038	60.2	0.284	-98.8
900	0.813	-85.0	5.900	125.9	0.039	59.1	0.299	-100.1
1,000	0.800	-89.2	5.485	123.4	0.041	59.5	0.312	-100.4
1,100	0.790	-92.6	5.110	121.3	0.041	59.4	0.323	-100.5
1,200	0.780	-95.5	4.780	119.3	0.043	60.2	0.335	-100.0
1,300	0.773	-97.7	4.498	117.7	0.043	61.6	0.345	-99.3
1,400	0.766	-99.6	4.225	116.2	0.044	62.3	0.354	-98.2
1,500	0.760	-100.9	3.987	115.3	0.045	64.1	0.364	-97.1
1,600	0.754	-102.0	3.769	114.4	0.045	65.9	0.372	-95.7
1,700	0.751	-102.7	3.588	113.6	0.045	67.7	0.380	-94.3
1,800	0.748	-103.3	3.426	112.9	0.046	70.0	0.388	-92.6
1,900	0.743	-103.5	3.268	112.3	0.046	71.8	0.397	-90.9
2,000	0.741	-103.8	3.119	111.7	0.047	74.525	0.404	-89.2

f	F _{min}	$\Gamma_{\sf opt}$		R_n	r _n
GHz	dB	MAG	ANG	Ω	-
0.9	0.79	0.564	61	13.4	0.267
1.8	1.47	0.585	99	13.6	0.272

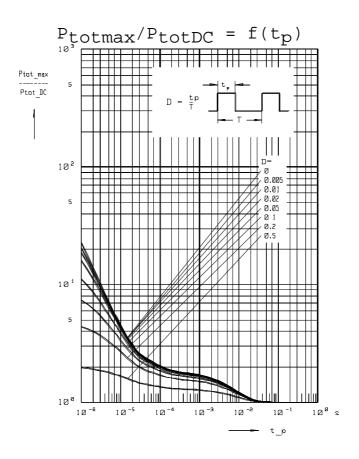
Additional S-Parameter and noise data available on data disc!

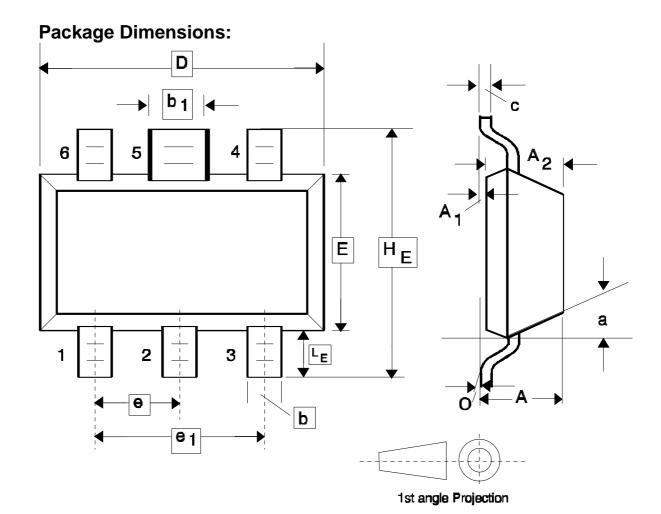
Electrical Characteristics, Continued:

Total Power Dissipation



Permissible Pulse Load



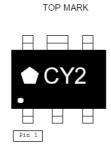


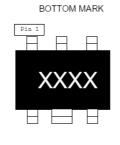
Dim.	min.	nom.	max.	Gradient	Remark
Α	\		1.1		
A ₁			0.1		
A_2			1.0		
b		0.3			
b ₁		0.6			
С	0.08		0.15		
D	2.8		3.0		
Е	1.2		1.4		
e		0.95			
e ₁		1.9			
H_{F}			2.6		
L _F			0.6		
а				max 10°	1
q				2°30°	·

1. MSL Rating: 1/260C

2. Pb Free

Package Marking:





Package Orientation on Reel:



Ordering Information:

Type	Marking		Pin Configuration					
	_	. 1	2	3	4	5	6	
CLY 2	CY2	G	S	D	D	S	G	MW 6

ESD: **E**lectro**s**tatic **d**ischarge sensitive device, observe handling precautions!

Additional Information

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